

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Toyohiko KUMAKURA, et al.

Group Art Unit: 2827 Serial No.: 09/237,860

Examiner: K. Cuneo Filed: January 27, 1999

WIRING BOARD, SEMICONDUCTOR DEVICE, ELECTRONIC DEVICE, For:

AND CIRCUIT BOARD FOR ELECTRONIC PARTS

SUPPLEMENTAL AMENDMENT

Commissioner for Patents Washington, DC 20231

Sir:

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Prior to consideration of the Amendment filed June 5, 2002, with an RCE, please in the plaims as follows: additionally amend the claims as follows:

IN THE CLAIMS

Please amend claim 1 as follows:

A wiring board for a semiconductor device, comprising: 1. a predetermined wiring section being disposed on an insulation board; and an electromagnetic shielding film being placed at a position close to said wiring section,

wherein a distance defined between, said wiring section and said electromagnetic shielding film is 50 µm or less, a volume specific resistance of said electromagnetic shielding film is 30 $\mu\Omega$ ·cm or less at room temperature, and

wherein, over an applicable frequency between about 10MHz to 15GHz, and

inductance of said wiring section and inductive cross talk are reduced.

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